

Patent References: Clay / Nanocomposites

Company

Du Pont Japan, Ltd., Japan; du Pont de Nemours, E. I., and

Title

Production of polyimide composite moldings

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Jpn. Kokai Tokkyo Koho, 5 pp. CODEN: JKXXAF Pl. JP09194724 A2

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LA Japanese

Abstract:

The title moldings, e.g., precise bearings, sealings, etc. (no data), are

manufd. by dispersing tetraalkyl ammonium salt-treated clays (e.g.,

On hand?

trioctylmethylammonium chloride-treated ***montmorillonite***) in basic solvents (e.g., pyridine, .beta.-picoline), mixing with polyamic acids (e.g., biphenyltetracarboxylic diaphydride-m-phenylenediamine copolymer)

biphenyltetracarboxylic dianhydride-m-phenylenediamine copolymer), adding poor solvents (e.g., acetone) to ppt. the polyamic acid composite,

NO

and heating (e.g., sintering) to give a polyimide composite.